PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Ho-chul Ji	09/16/2010
Ki-nam Kim	09/24/2010
Yong-woo Hyung	09/17/2010
Kyoung-won Na	09/16/2010
Kyoung-ho Ha	09/16/2010
Yoon-dong Park	09/16/2010
Dae-lok Bae	09/20/2010
Jin-kwon Bok	09/27/2010
Pil-kyu Kang	09/20/2010
Sung-dong Suh	09/16/2010
Seung-gu Kim	09/16/2010
Dong-jae Shin	09/16/2010
In-sung Joe	09/16/2010

RECEIVING PARTY DATA

Name:	Samsung Electronics Co., Ltd.	
Street Address:	416, Maetan-dong, Yeongtong-gu	
City:	Suwon-si, Gyeonggi-do	
State/Country:	REPUBLIC OF KOREA	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12911415

CORRESPONDENCE DATA

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PATENT 501330010 REEL: 025189 FRAME: 0875

DP \$40.00 12911415

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ATTORNEY DOCKET NUMBER: SAM-1457

NAME OF SUBMITTER: Steven M. Mills

Total Attachments: 4

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PATENT REEL: 025189 FRAME: 0876

ASSIGNMENT

We, Ho-chul Ji, of 411-1102, Nokwon Maeul Saecheonnyeon Greenvill 4-danji Apt., Singal-dong, Giheung-gu, Yongin-si, Gyeonggi-do, Republic of Korea; Ki-nam Kim, of 109-1206, Hanbo Mido Apt., 511, Daechi-dong, Gangnam-gu, Seoul, Republic of Korea; Yong-woo Hyung, of 520-1404, Samsung 5-cha Apt., Pungdeokcheon 2-dong, Suji-gu, Yongin-si, Gyeonggi-do, Republic of Korea; Kyoung-won Na, of Rm. 101, 70-4, Ogeum-dong, Songpa-gu, Seoul, Republic of Korea; Kyoung-ho Ha, of 262-9, Nonhyeon-dong, Gangnam-gu, Seoul, Republic of Korea; Yoon-dong Park, of Samsung Advanced Institute of Technology, Nongseo-dong, Giheung-gu, Yongin-si, Gyeonggi-do, Republic of Korea; Dae-lok Bae, of 212-2903, Park Rio Apt., Jamsil 4-dong, Songpa-gu, Seoul, Republic of Korea; Jin-kwon Bok, of 244-1204, Hwanggol Maeul 2-danji Ssangyong Apt., Yeongtong-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea; Pil-kyu Kang, of 610-1209, Saetbyeol Hanyang Apt., Daran-dong, Dongan-gu, Anyang-si, Gyeonggi-do, Republic of Korea; Sung-dong Suh, of 5F, Seongho Bldg., 592-9, Sinsa-dong, Gangnam-gu, Seoul, Republic of Korea; Seong-gu Kim, of 288-36, Pyeongtaek-dong, Pyeongtaek-si, Gyeonggi-do, Republic of Korea; Dong-jae Shin, of 323-304, III-Zium Apt., Jamsil-dong, Songpa-gu, Seoul, Republic of Korea; and In-sung Joe, of 101-904, Dogok Rexle Apt., Dogok 2-dong, Gangnam-gu, Seoul, Republic of Korea: having invented improvements in OPTICAL WAVEGUIDE AND COUPLER APPARATUS AND METHOD OF MANUFACTURING THE SAME identified as Attorney Docket No. SAM-1457, described in an application for Letters Patent of the United States, which application was filed on October 25, 2010 , and assigned Serial No. 12/911,415 (in the event that the execution date, filing date and/or Serial No. are not entered above at the time we execute this document, and if such information is deemed necessary, we hereby authorize and request our attorneys at Mills & Onello, LLP, Eleven Beacon Street, Suite 605, Boston, Massachusetts 02108, USA, to insert above the execution date, filing date and/or Serial No. of said application, when known), for good and valuable consideration, receipt of which is hereby acknowledged from Samsung Electronics Co., Ltd., a Korean corporation having a place of business at 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea (and hereinafter called the Assignee, which term shall include its successors and assigns), do hereby sell, assign and transfer unto the Assignee our entire right, title, and interest in and throughout the United States of America (including its territories and dependencies) and all countries foreign thereto, in and to and under said application (which term shall include hereinafter where the context so admits all divisional, continuing, reissue and other patent applications based thereon) and the inventions (which term shall include each and every such invention, or part thereof) therein described, and any and all patents and like rights of exclusion (including extensions thereof) of any country which may be granted on or for said inventions or on said application;

And for the same consideration We do also hereby sell, assign, and transfer unto the Assignee, all our rights under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, and all other treaties of like purpose in respect of said inventions and said application, and We do hereby authorize the Assignee to apply in our name or its own name or its designee for patents and like rights of exclusion on or for said inventions in all countries, claiming (if the Assignee so desires) the priority of the filing date of said application under the provisions of said Convention, Treaty or any such other Convention or Treaty;

And for the same consideration, We do hereby agree for ourselves and for our heirs, executors, and administrators, promptly upon request of the Assignee to execute and deliver without further compensation any power of attorney, assignment, original, divisional, continuing, reissue or other application or applications for patent or patents or like rights of exclusion of any country, or other lawful documents and any further assurances that may be deemed necessary or desirable by the Assignee, fully to secure to it said right, title, and interest as aforesaid in and to said inventions, applications, and said several patents and like rights of exclusion (including extensions thereof) or any of them, all, however, at the expense of the Assignee, its successors, or assigns;

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And We do hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America and the corresponding Official of each country foreign thereto to issue to the Assignee, any and all patents and like rights of exclusion which may be granted in any country upon said United States application on or for said inventions;

And We do hereby covenant for ourselves and our legal representatives and agree with the Assignee, that We have granted no right or license to make, use, or sell said inventions to anyone except the Assignee, that prior to the execution of this deed our right, title, and interest in and to said inventions has not been otherwise encumbered by us, and that We have not executed and will not execute any instruments in conflict herewith.

First or Sole Inventor	First	or	Sole	Inventor:
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Signature:

The chil

Date: 20(0, 6), (6.

Second Joint Inventor:

Signature:

Third Joint Inventor:

Signature: Yong-woo Hyung Date: September 17, 200

Fourth Joint Inventor:

Signature:

Kyoung-won Na

Date: 2010-9. (6

Fifth Joint Inventor:

Kyourho Ha Date: 2010, 9, 16.

Sixth Joint Inventor:

Seventh Joint Inventor:

Signature:

Date: 20/9/2010

Eighth Joint Inventor:

Signature:

Ninth Joint Inventor:

Signature:

Date: 20/9/20/0

Tenth Joint Inventor:

Signature:

Date: 2010. 9. 16.

Attorney Reference No.: SAM-1457

Eleventh Joint Inventor:

Signature:

Seong-gu Kim

Date: 2010_9. (6.

Twelfth Joint Inventor:

Signature:

DONG-JAZ SHIN

Date: 2010. 9. (6.

Thirteenth Joint Inventor:

Signature:

In-sung Joe

Date: 2010. 9.16.

ATTORNEY REFERENCE NO.: SAM-1457 J:\SAM\1457\1457_ASSIGNMENT.DOC